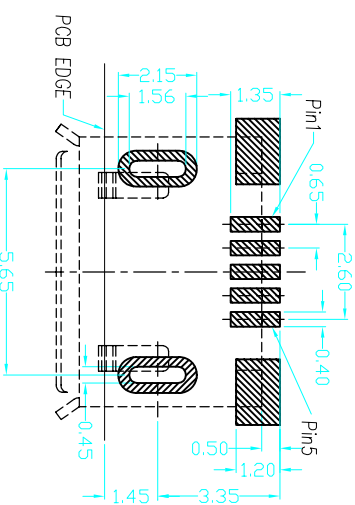
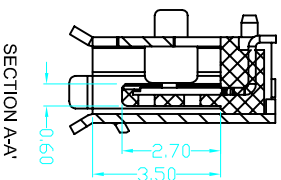
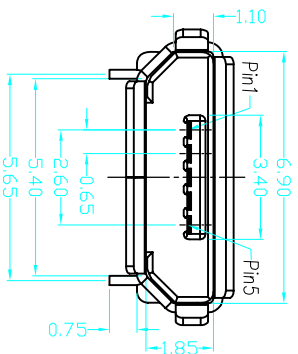
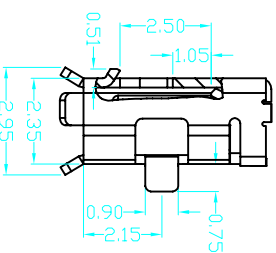
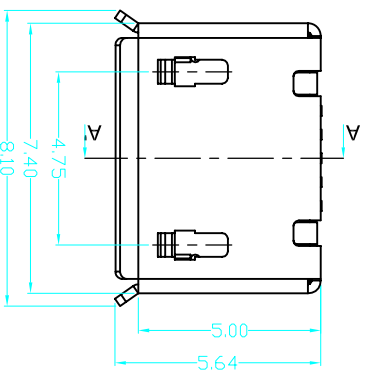
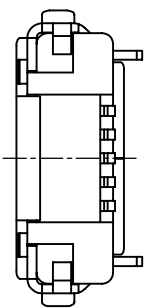


SIGN	DATE	DESCRIPTION	APPROVER
△			
△			
△			



RECOMMENDED PCB LAYOUT

Notes:

1. Materials:
 - 1.1 Housing: High temperature thermoplastic with g.f.f:UL94 V-0.
 - 1.2 Contact: copper alloy,t=0.20mm.
 - 1.3 Shell: copper alloy,t=0.25mm.
2. Specifications:
 - 2.1. Current rating: 1 A Max.
 - 2.2. Dielectric withstanding:voltage: 100 V(ac) for 1 min.
 - 2.3. Contact resistance: 50 mΩ Max.
 - 2.4. Insulation resistance: 100 MW Min.
 - 2.5. Total mating force: 3.57 Kgf Max.
 - 2.6. Total unmating force: 1.0 Kgf Min, 0.81~2.05 Kgf Min,after 10000 insertion/extraction cycles
 - 2.7. Temperature range: -30°C~+80°C

XIMEI TECHNOLOGY CO., LTD

PART NAME: MICO USB TITLE: MICO USB SPIN FEMALE DIP I

PART NO.: 45330517 DWG NAME:

APPROVED BY	CHECKED BY	DESIGNED BY	UNITS: mm	Tolerance
Andy Zhang 2006.7.8		Patty Ling 2006.7.8	SCALE: 1/1	X.X ±0.10
			REVISION: A	X.XX ±0.05
				X ±0